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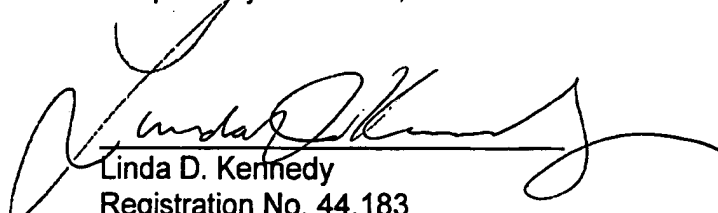
IN THE SPECIFICATION

On page 1 on line 4 before the section entitled "FIELD OF THE INVENTION,"
please insert the following paragraph:

~~CROSS-REFERENCE TO RELATED APPLICATIONS~~

This application is a continuation-in-part of U.S. application serial no. 09/789,346
filed Feb. 20, 2001, entitled "Spherical Cap-Shaped Polishing Head in a Chemical
Mechanical Polishing Apparatus for Semiconductor Wafers."

Respectfully submitted,


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